January 2001

Si9926DY

SEMICONDUCTOR IM

Dual N-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

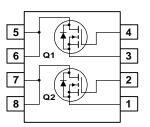
These N-Channel 2.5V specified MOSFETs use Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 10V).

Applications

- Battery protection
- Load switch
- Power management



- 6.5 A, 20 V. $R_{DS(ON)} = 0.030 \ \Omega \ @ V_{GS} = 4.5 \ V$ $R_{DS(ON)} = 0.043 \ \Omega \ @ V_{GS} = 2.5 \ V.$
- Optimized for use in battery protection circuits
- + $\pm 10 \; V_{GSS}$ allows for wide operating voltage range
- Low gate charge



Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

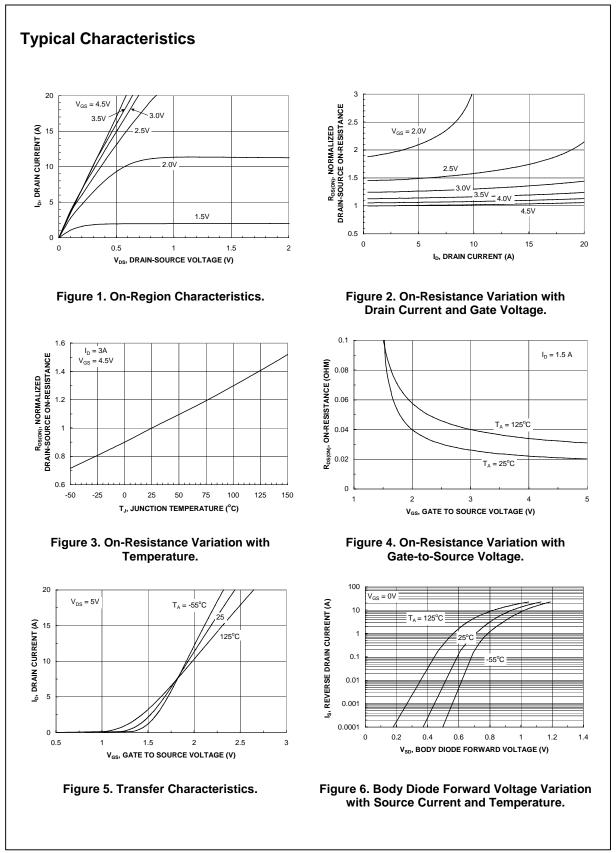
Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Sour	Source Voltage		20	V	
V _{GSS}	Gate-Source Voltage			±10	V	
I _D	Drain Current – Continuous (Note 1a)		(Note 1a)	6.5	A	
		- Pulsed		20		
P _D	Power Dissipation for Dual Operation			2	W	
	Power Dissipation for Single Operation (N		n (Note 1a)	1.6		
			(Note 1b)	1		
			(Note 1c)	0.9		
T _J , T _{STG}	Operating a	Operating and Storage Junction Temperature Range		-55 to +150	°C	
Therma	l Charac	teristics	·			
R _{0JA}	Thermal Re	al Resistance, Junction-to-Ambient (Note 1a)		78	°C/W	
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)		e (Note 1)	40	°C/W	
Packag	e Markin	g and Ordering I	nformation			
Device Marking		Device	Reel Size	Tape width	Quantity	
9926		Si9926DY	13"	12mm	2500 units	

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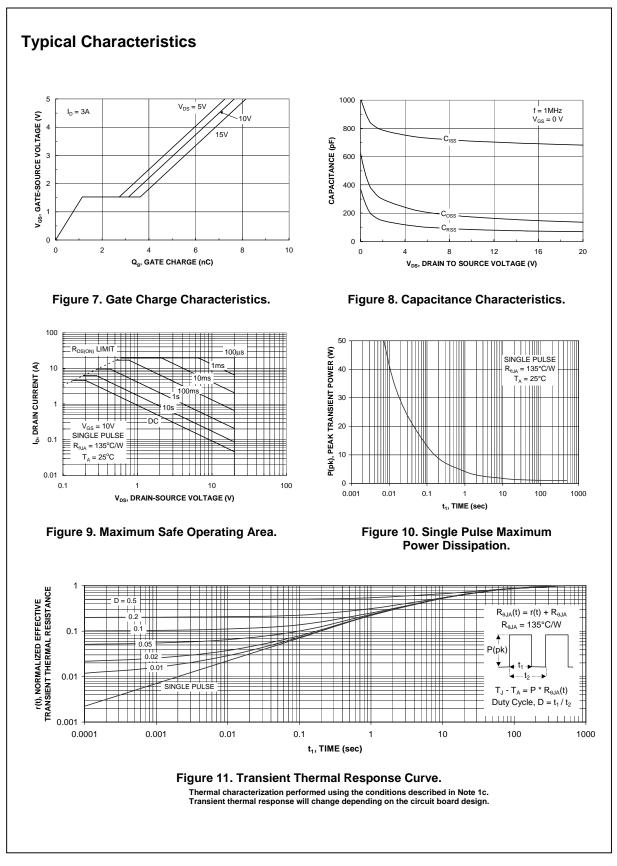
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
3V _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \ \mu\text{A}$	20			V
<u>ΔBVdss</u> ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		14		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 16 V$, $V_{GS} = 0 V$			1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
GS(th)	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	0.5	1	1.5	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3		mV/°C
RDS(on)	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, I_D = 6.5 \ A \\ V_{GS} = 2.5 \ V, I_D = 5.4 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 6.5 \ A, \ T_J = 125^\circ C \end{array} $		0.025 0.036 0.035	0.030 0.043 0.050	Ω
D(on)	On–State Drain Current	$V_{GS} = 4.5 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	15			Α
FS	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 3 A$		11		S
Dynamic	Characteristics	•			•	
Siss	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		700		pF
oss	Output Capacitance	f = 1.0 MHz		175		pF
	Reverse Transfer Capacitance	-		85		pF
	g Characteristics (Note 2)		1		1	
d(on)	Turn–On Delay Time	$V_{DD} = 10 \text{ V}, \qquad I_D = 1 \text{ A},$		8	16	ns
n (ON)	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		10	18	ns
d(off)	Turn-Off Delay Time	-		18	29	ns
u(011)	Turn-Off Fall Time	-		5	10	ns
λ ^g	Total Gate Charge	$V_{DS} = 10 V$, $I_{D} = 3A$,		7	10	nC
λ _{gs}	Gate–Source Charge	$V_{GS} = 4.5 V$		1.2		nC
2 _{gd}	Gate–Drain Charge	-		1.9		nC
-	3	and Maximum Patinga				
s s s	ource Diode Characteristics a Maximum Continuous Drain–Source				1.3	А
/ _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 1.3 \text{ A} (\text{Note 2})$		0.65	1.2	V
	n of the junction-to-case and case-to-ambient therm $R_{\theta LC}$ is guaranteed by design while $R_{\theta CA}$ is determ a) 78°/W when mounted on a 0.5in ² pad of 2 oz copper		یں c)		nen mounte	

Si9926DY Rev A (W)



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